

NCE N-Channel Enhancement Mode Power MOSFET

Description

The NCE01H13D uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

General Features

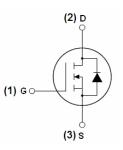
- $V_{DS} = 100V, I_D = 130A$ $R_{DS(ON)} < 6.8 m\Omega @ V_{GS} = 10V$ (Typ:5.3 m Ω)
- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high E_{AS}
- Excellent package for good heat dissipation
- Special process technology for high ESD capability

Application

- Power switching application
- Hard switched and high frequency circuits
- Uninterruptible power supply

100% UIS TESTED!

100% AVds TESTED!



Schematic diagram



Marking and pin assignment



TO-263-2L top view

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE01H13D	NCE01H13D	TO-263-2L	-	-	-

Absolute Maximum Ratings (T_C=25 ℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V _{DS}	100	V
Gate-Source Voltage	V _{GS}	±20	V
Drain Current-Continuous	I _D	130	Α
Drain Current-Continuous(T _C =100 °C)	I _D (100℃)	92	Α
Pulsed Drain Current	I _{DM}	520	Α
Maximum Power Dissipation	P _D	285	W
Derating factor		1.9	W/℃
Single pulse avalanche energy (Note 5)	E _{AS}	1100	mJ
Operating Junction and Storage Temperature Range	T_{J} , T_{STG}	-55 To 175	$^{\circ}$



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Thermal Characteristic

Thermal Resistance, Junction-to-Case ^(Note 2)	R _{eJC}	0.53	°C/W	
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Electrical Characteristics (T_C=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics	·		•			
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250μA	100	110	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =100V,V _{GS} =0V	-	-	1	μΑ
Gate-Body Leakage Current	I _{GSS}	V_{GS} =±20 V , V_{DS} =0 V	-	-	±100	nA
On Characteristics (Note 3)			•			•
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}$, $I_{D}=250\mu A$	2	3	4	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =20A	-	5.3	6.8	mΩ
Forward Transconductance	g FS	V_{DS} =5 V , I_D =20 A	40	-	-	S
Dynamic Characteristics (Note4)			•			•
Input Capacitance	C _{lss}	V _{DS} =50V,V _{GS} =0V,	-	6979.8	-	PF
Output Capacitance	C _{oss}		-	414.6	-	PF
Reverse Transfer Capacitance	C _{rss}	F=1.0MHz	-	321.3	-	PF
Switching Characteristics (Note 4)			•			•
Turn-on Delay Time	$t_{d(on)}$		-	31	-	nS
Turn-on Rise Time	t _r	V_{DD} =50V, R_L =2.5 Ω	-	24	-	nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =10 V , R_{GEN} =3 Ω	-	45	-	nS
Turn-Off Fall Time	t _f		-	27	-	nS
Total Gate Charge	Qg	V _{DS} =50V,I _D =20A,	-	178	-	nC
Gate-Source Charge	Q _{gs}		-	41.9	-	nC
Gate-Drain Charge	Q_{gd}	V _{GS} =10V	-	72.6	-	nC
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 3)	V_{SD}	V _{GS} =0V,I _S =40A	-	0.85	1.2	V
Diode Forward Current (Note 2)	Is		-	-	130	Α
Reverse Recovery Time	t _{rr}	TJ = 25°C, IF =20A	-	65	-	nS
Reverse Recovery Charge	Qrr	$di/dt = 100A/\mu s^{(Note3)}$	-	110	-	nC
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD)				

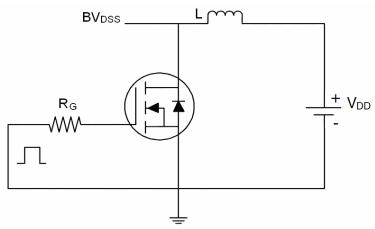
Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, t ≤ 10 sec.
- 3. Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2%.
- 4. Guaranteed by design, not subject to production
- 5. EAS condition:Tj=25 $^{\circ}$ C,V_{DD}=50V,V_G=10V,L=1mH,Rg=25 Ω

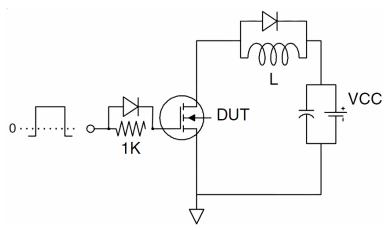


Test Circuit

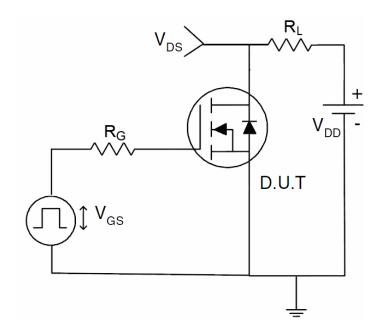
1) E_{AS} test Circuit



2) Gate charge test Circuit



3) Switch Time Test Circuit





Typical Electrical and Thermal Characteristics (Curves

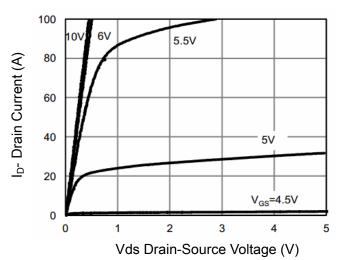


Figure 1 Output Characteristics

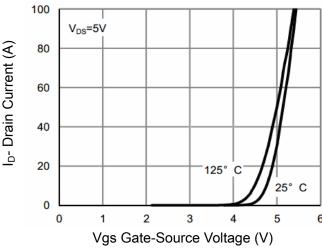


Figure 2 Transfer Characteristics

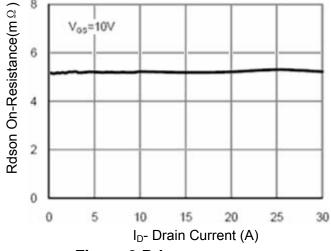


Figure 3 Rdson- Drain Current

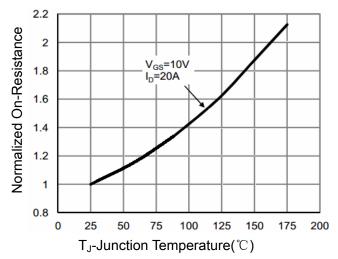


Figure 4 Rdson-JunctionTemperature

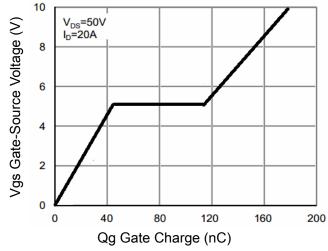


Figure 5 Gate Charge

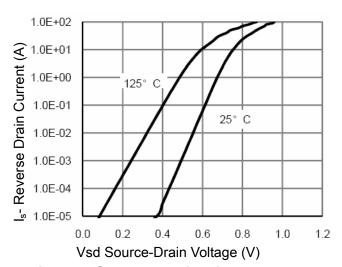


Figure 6 Source- Drain Diode Forward



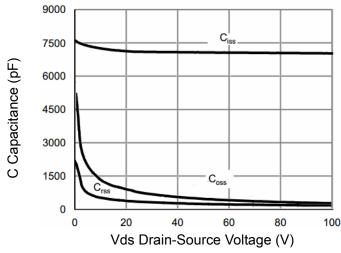


Figure 7 Capacitance vs Vds

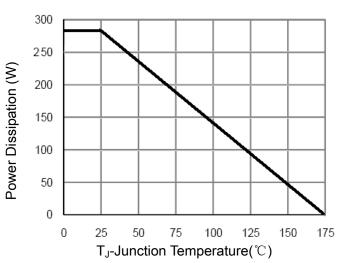


Figure 9 Power De-rating

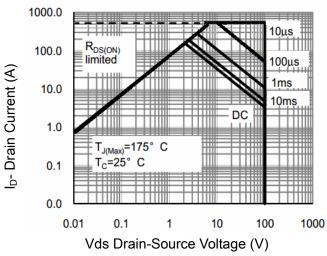


Figure 8 Safe Operation Area

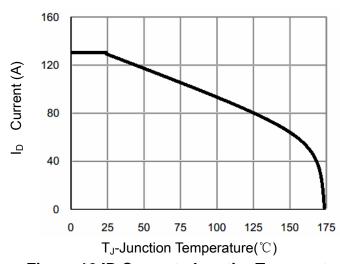
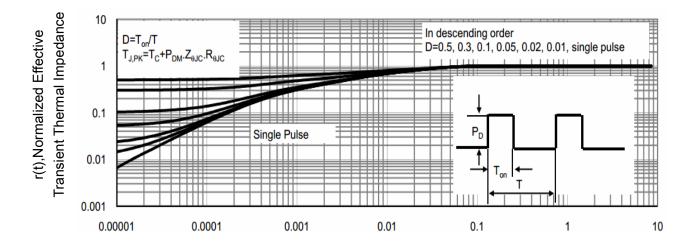


Figure 10 ID Current- JunctionTemperature

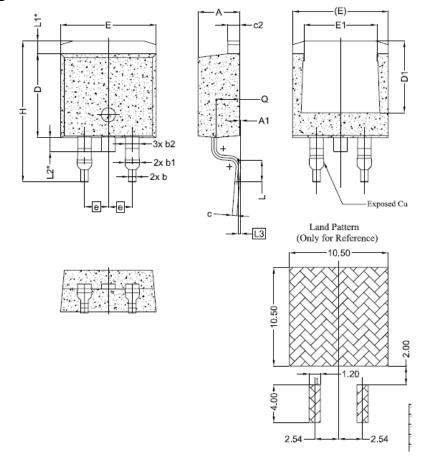


Square Wave Pluse Duration(sec)

Figure 11 Normalized Maximum Transient Thermal Impedance



TO-263-2L Package Information



	DIMENSIONS			
SYMBOL	MIN.	NOM.	MAX.	
Α	4.24	4.44	4.64	
A1	0.00	0.10	0.25	
b	0.70	0.80	0.90	
b1	1.20	1.55	1.75	
b2	1,20	1,45	1,70	
С	0.40	0.50	0.60	
c2	1,15	1,27	1,40	
D	8.82	8.92	9.02	
D1	6.86	7.65	_	
E	9.96	10.16	10,36	
E1	6,89	7.77	7.89	
е	2.54 BSC			
Н	14,61	15,00	15,88	
L	1.78	2.32	2.79	
L1	1.36 REF.			
L2	1.50 REF.			
L3	0.25 BSC			
Q	2.30	2.48	2.70	



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